

700V / 2A
N-Channel Enhancement Mode MOSFET

700V, $R_{DS(ON)}=6.5\Omega@V_{GS}=10V, I_D=1A$

Features

- Low On-State Resistance
- Fast Switching
- Low Gate Charge & Low C_{RSS}
- Fully Characterized Avalanche Voltage and Current
- Specially Designed for AC Adapter, Battery Charger and SMPS
- In compliance with EU RoHs 2002/95/EC Directives

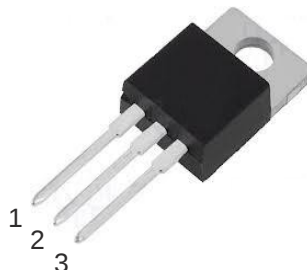
Mechanical Information

- Case: TO-220AB / ITO-220AB Molded Plastic
- Terminals : Solderable per MIL-STD-750, Method 2026

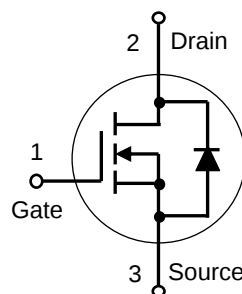
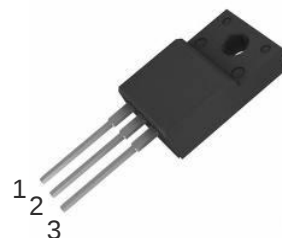
Marking & Ordering Information

TYPE	MARKING	PACKAGE	PACKING
HY2N70T	2N70T	TO-220AB	50PCS/TUBE
HY2N70FT	2N70FT	ITO-220AB	50PCS/TUBE

TO-220AB



ITO-220AB



Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

Parameter		Symbol	HY2N70T	HY2N70FT	Units
Drain-Source Voltage		V_{DS}	700		V
Gate-Source Voltage		V_{GS}	± 30		V
Continuous Drain Current	$T_c=25^\circ\text{C}$	I_D	2	2	A
Pulsed Drain Current ¹⁾		I_{DM}	8	8	A
Maximum Power Dissipation	$T_c=25^\circ\text{C}$	P_D	44.5	19.2	W
Derating Factor			0.36	0.16	
Avalanche Energy with Single Pulse $I_{AS}=2A, V_{DD}=60V, L=60mH$		E_{AS}	120		mJ
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to +150		$^\circ\text{C}$

Note : 1. Maximum DC current limited by the package

Thermal Characteristics

Parameter	Symbol	HY2N70T	HY2N70FT	Units
Junction-to-Case Thermal Resistance	$R_{\theta JC}$	2.8	6.5	$^\circ\text{C/W}$
Junction-to-Air Thermal Resistance	$R_{\theta JA}$	50	110	$^\circ\text{C/W}$

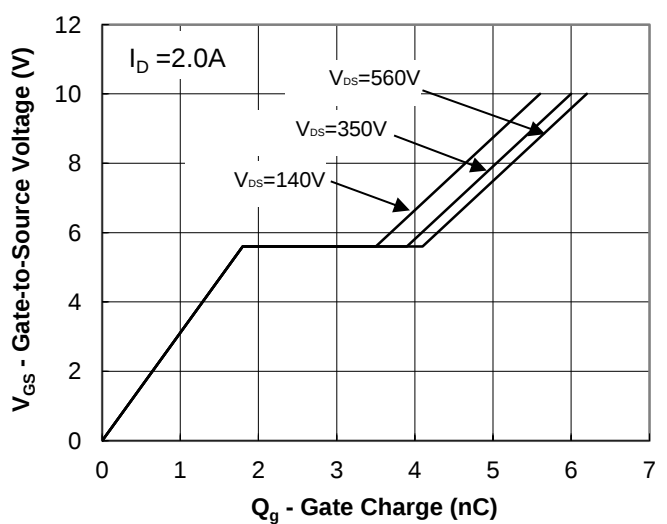
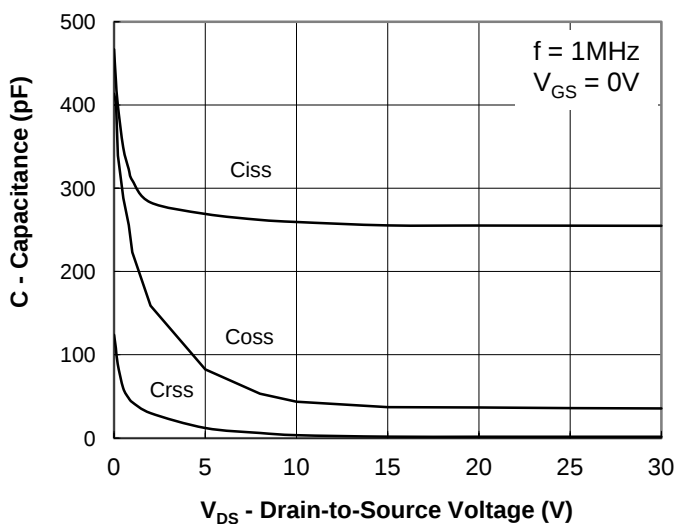
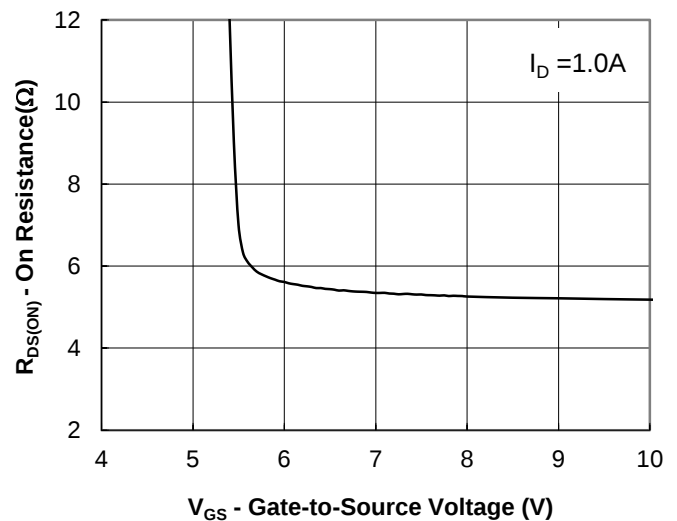
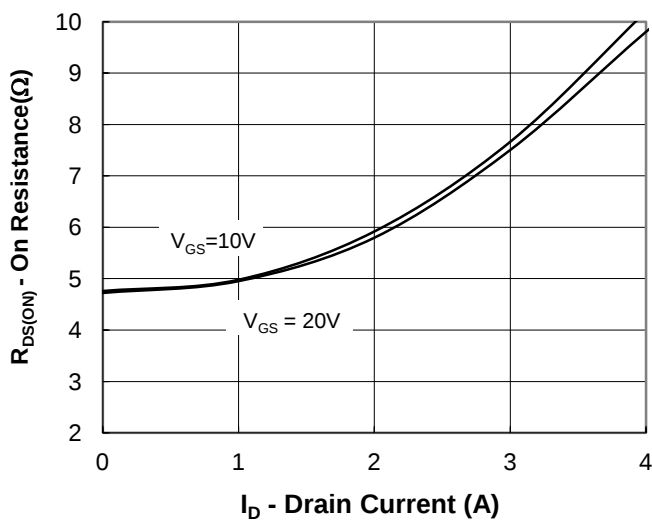
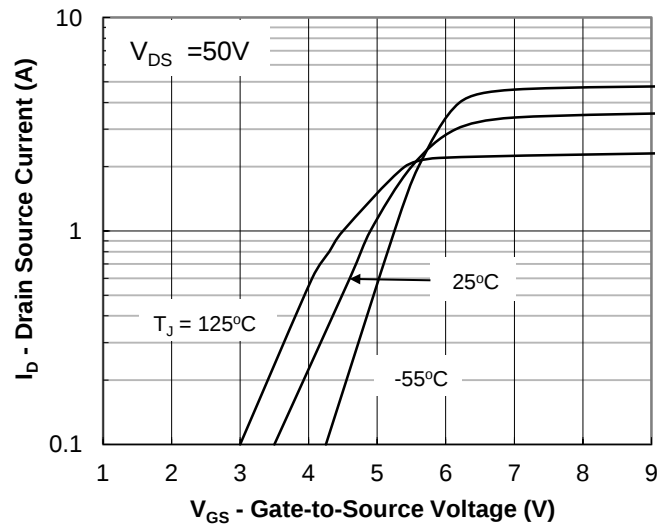
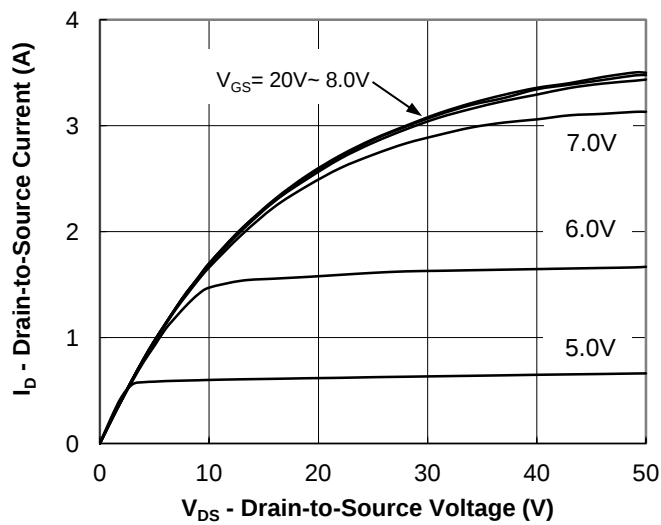
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Electrical Characteristics ($T_c=25^{\circ}\text{C}$, Unless otherwise noted)

Paramter	Symbol	Test Condition	Min.	Typ.	Max.	Units
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V 、 I _D =250uA	700	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} 、 I _D =250uA	2.0	-	4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V 、 I _D =1A	-	5.0	6.5	Ω
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =700V 、 V _{GS} =0V	-	-	10	uA
Gate Body Leakage Current	I _{GSS}	V _{GS} =±30V 、 V _{DS} =0V	-	-	±100	nA
Dynamic						
Total Gate Charge	Qg	V _{DS} =560V 、 I _D =2A V _{GS} =10V	-	6.2	7.8	nC
Gate-Source Charge	Qgs		-	1.8	-	
Gate-Drain Charge	Qgd		-	2.3	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} =350V 、 I _D =2A V _{GS} =10V 、 R _G =25Ω	-	12.8	16	ns
Turn-On Rise Time	t _r		-	26.8	36	
Turn-Off Delay Time	t _{d(off)}		-	16.8	28	
Turn-Off Fall Time	t _f		-	18.8	32	
Input Capacitance	C _{iss}	V _{DS} =25V 、 V _{GS} =0V f=1.0M _{HZ}	-	255	-	pF
Output Capacitance	C _{oss}		-	32	-	
Reverse Transfer Capacitance	C _{rss}		-	1.7	-	
Source-Drain Diode						
Max. Diode Forwad Voltage	I _S	-	-	-	2.0	A
Max. Pulsed Source Current	I _{SM}	-	-	-	8.0	A
Diode Forward Voltage	V _{SD}	I _S =2A 、 V _{GS} =0V	-	-	1.4	V
Reverse Recovery Time	t _{rr}	V _{GS} =0V 、 I _S =2A di/dt=100A/us	-	210	-	ns
Reverse Recovery Charge	Q _{rr}		-	1.1	-	uC

NOTE : Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$

Typical Characteristics Curves ($T_C=25^\circ\text{C}$, unless otherwise noted)



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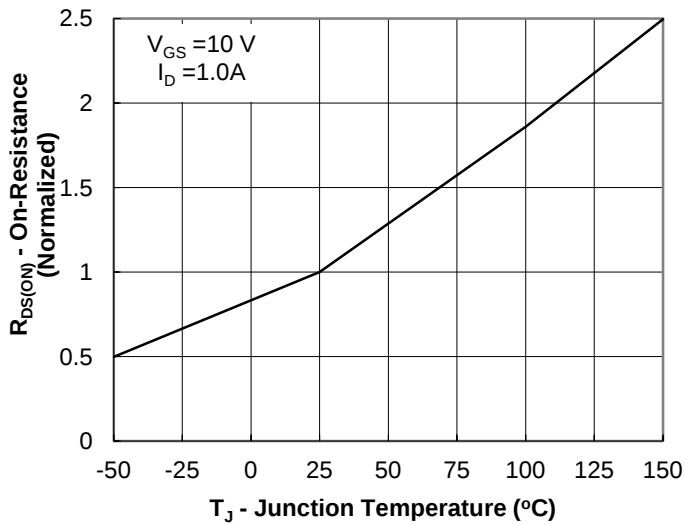


Fig.7 On-Resistance vs Junction Temperature

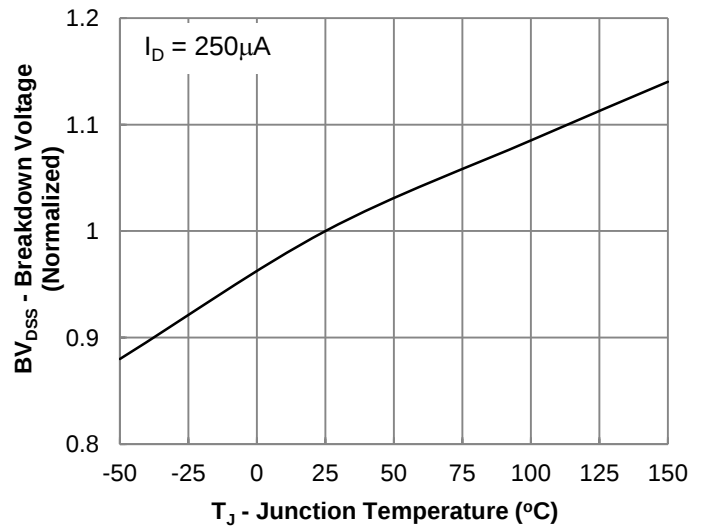


Fig.8 Breakdown Voltage vs Junction Temperature

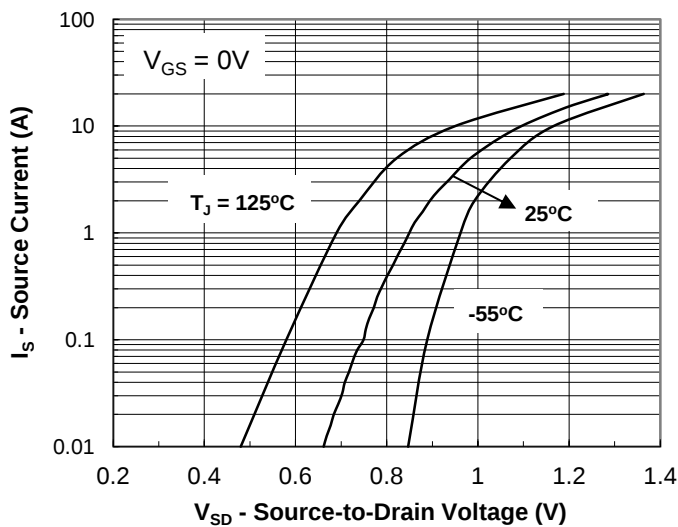


Fig.9 Body Diode Forward Voltage Characteristic